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Vishay Siliconix

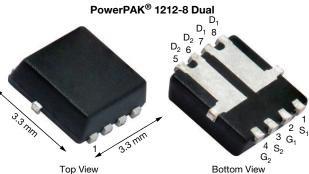
RoHS

COMPLIANT

HALOGEN

FREE

 D_2



PRODUCT SUMMARY					
V _{DS} (V)	30				
$R_{DS(on)}$ max. (Ω) at V_{GS} = 4.5 V	0.022				
$R_{DS(on)}$ max. (Ω) at V_{GS} = 2.5 V	0.026				
Q _g typ. (nC)	9.2				
I _D (A)	6 ^{a, g}				
Configuration	Dual				

FEATURES

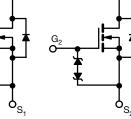
N-Channel 30 V (D-S) MOSFET

- TrenchFET[®] power MOSFET
- Typical ESD (HBM): 1900 V
- 100 % R_q and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

G

APPLICATIONS

- DC/DC converters
- H-bridge
- · Load switch
- Battery protection



D

N-Channel MOSFET



ORDERING INFORMATION

	PowerPAK 1212-8
Lead (Pb)-free and halogen-free Si	SiS932EDN-T1-GE3

ABSOLUTE MAXIMUM RATING	iS (T _A = 25 °C, u	inless other	wise noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	30	v	
Gate-source voltage		V _{GS}	± 12	v	
	T _C = 25 °C		6 ^a		
Continuous drain current (T _J = 150 °C)	T _C = 70 °C] .	6 ^a		
	T _A = 25 °C	I _D	6 ^{b, c}		
	T _A = 70 °C		6 ^{b, c}	· .	
Pulsed drain current (t = 100 μs)		I _{DM}	40	— A	
Operation of the second	T _C = 25 °C		6 ^a	1	
Continuous source-drain diode current	T _A = 25 °C	I _S	2.2 ^{b, c}	1	
Single pulse avalanche current		I _{AS}	15		
Single pulse avalanche energy $L = 0.1 \text{ mH}$		E _{AS}	11.3	mJ	
	T _C = 25 °C		23		
Maximum a successfill size still a	T _C = 70 °C		14.8	w	
Maximum power dissipation	T _A = 25 °C	PD	2.6 ^{b, c}		
	T _A = 70 °C		1.7 ^{b, c}		
Operating junction and storage temperature range		T _J , T _{stq}	-55 to +150	**	
Soldering recommendations (peak temperature) c		İ	260	°C	

THEDMAL DEGISTANCE DATINGS

THENMAE RESISTANCE RATIN	45				
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient ^b	t ≤ 10 s	R _{thJA}	38	48	°C/W
Maximum junction-to-case (drain)	Steady state	R _{thJC}	4.3	5.4	C/W

Notes

а.

Package limited Surface mounted on 1" x 1" FR4 board b.

t = 10 s c.

See solder profile (www.vishay.com/doc?73257). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection Rework conditions: manual soldering with a soldering iron is not recommended for leadless components Maximum under steady state conditions is 94 °C/W d.

e.

f.

g. T_C = 25 °C

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Vishay Siliconix

SiS932EDN

SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)									
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT			
Static									
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	30	-	-	V			
V _{DS} temperature coefficient	$\Delta V_{DS}/T_J$	I _D = 250 μA	-	32	-				
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-3.8	-	mV/°C			
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	0.6	-	1.4	V			
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 12$	-	-	15				
Zere acto voltogo droin ourrent		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	μA			
Zero gate voltage drain current	IDSS	V_{DS} = 30 V, V_{GS} = 0 V, T_{J} = 70 °C	-	-	10				
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}$	5	-	-	А			
Drain-source on-state resistance ^a	Р	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	0.018	0.022	0			
Drain-source on-state resistance "	R _{DS(on)}	$V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 5 \text{ A}$	-	0.021	0.026	Ω			
Forward transconductance ^a	9 _{fs}	$V_{DS} = 5 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	45	-	S			
Dynamic ^b									
Input capacitance	C _{iss}		-	1000	-	pF			
Output capacitance	C _{oss}	V_{DS} = 15 V, V_{GS} = 0 V, f = 1 MHz	-	125	-				
Reverse transfer capacitance	C _{rss}		-	66	-				
Total gate charge	Qg		-	9.2	14				
Gate-source charge	Q _{gs}	V_{DS} = 15 V, V_{GS} = 4.5 V, I_D = 5 A	-	1.9	-	nC			
Gate-drain charge	Q _{gd}		-	2	-				
Gate resistance	Rg	f = 1 MHz	0.6	3.1	6.2	Ω			
Turn-on delay time	t _{d(on)}		-	15	30				
Rise time	tr	V_{DD} = 15 V, R_L = 3 Ω , $I_D \cong$ 5 A,	-	35	70	ns			
Turn-off delay time	t _{d(off)}	V_{GEN} = 4.5 V, R_g = 1 Ω	-	32	60				
Fall time	t _f		-	5	10				
Drain-Source Body Diode Characterist	ics								
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	6	٨			
Pulse diode forward current	I _{SM}		-	-	40	A			
Body diode voltage	V _{SD}	$I_{S} = 5 \text{ A}, V_{GS} = 0 \text{ V}$	-	0.84	1.2	V			
Body diode reverse recovery time	t _{rr}		-	15	30	ns			
Body diode reverse recovery charge	Q _{rr}	I _F = 5 A, di/dt = 100 A/μs, T _{.I} = 25 °C	-	8	20	nC			
Reverse recovery fall time	ta	$F = 3 A$, $u/ut = 100 A/\mu s$, $1J = 25 C$	-	10	-	20			
Reverse recovery rise time	t _b		-	5	-	ns			

Notes

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a. Pulse test; pulse width $\leq 300~\mu\text{s},~\text{duty}~\text{cycle} \leq 2~\%$

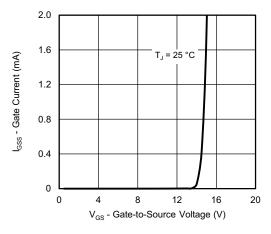
b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

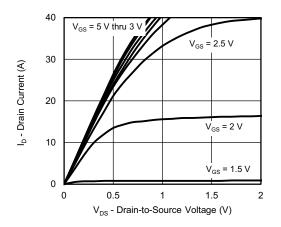


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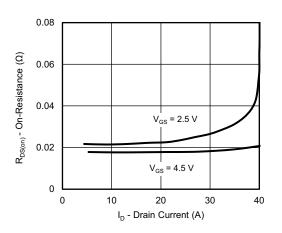
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



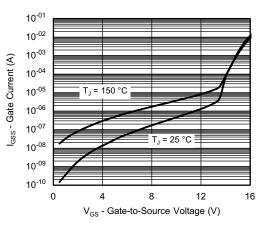
Gate Current vs. Gate-to-Source Voltage



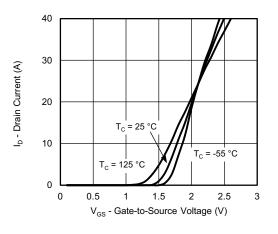
Output Characteristics



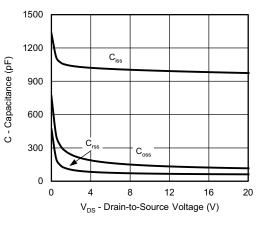
On-Resistance vs. Drain Current and Gate Voltage



Gate Current vs. Gate-to-Source Voltage



Transfer Characteristics



Capacitance

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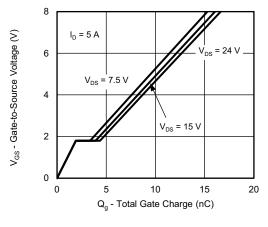
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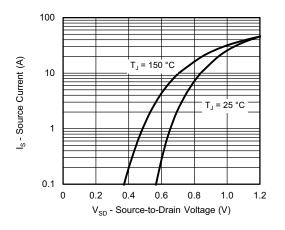


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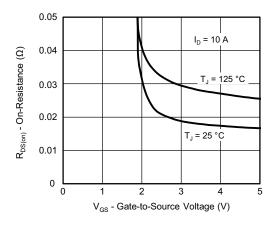
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



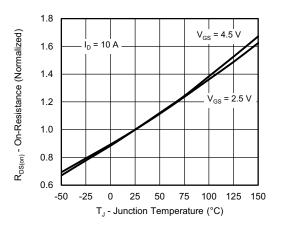
Gate Charge



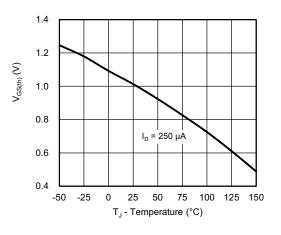
Source-Drain Diode Forward Voltage



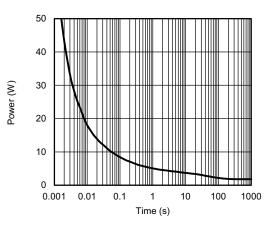
On-Resistance vs. Gate-to-Source Voltage



On-Resistance vs. Junction Temperature



Threshold Voltage



Single Pulse Power, Junction-to-Ambient

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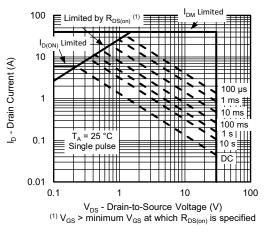
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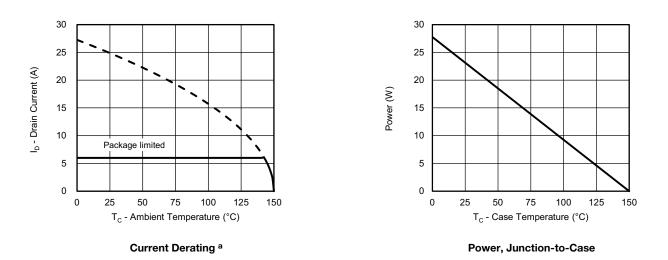


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Safe Operating Area, Junction-to-Ambient



Note

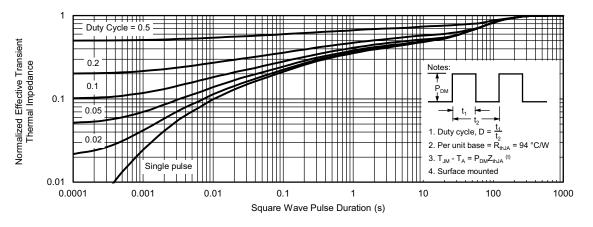
a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

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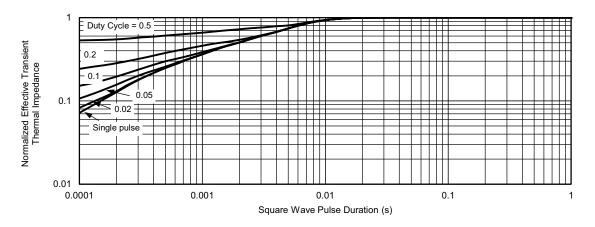


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?74547.

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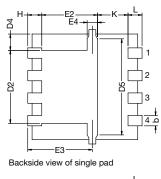


Vishay Siliconix

PowerPAK® 1212-8, (Single / Dual)









Notes

1. Inch will govern

Dimensions exclusive of mold gate burrs
Dimensions exclusive of mold flash and cutting burrs

DIM.		MILLIMETERS			INCHES			
DINI.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.		
А	0.97	1.04	1.12	0.038	0.041	0.044		
A1	0.00	-	0.05	0.000	-	0.002		
b	0.23	0.30	0.41	0.009	0.012	0.016		
С	0.23	0.28	0.33	0.009	0.011	0.013		
D	3.20	3.30	3.40	0.126	0.130	0.134		
D1	2.95	3.05	3.15	0.116	0.120	0.124		
D2	1.98	2.11	2.24	0.078	0.083	0.088		
D3	0.48	-	0.89	0.019	-	0.035		
D4		0.47 typ.		0.0185 typ				
D5		2.3 typ.			0.090 typ			
E	3.20	3.30	3.40	0.126	0.130	0.134		
E1	2.95	3.05	3.15	0.116	0.120	0.124		
E2	1.47	1.60	1.73	0.058	0.063	0.068		
E3	1.75	1.85	1.98	0.069	0.073	0.078		
E4		0.034 typ.			0.013 typ.			
е		0.65 BSC		0.026 BSC				
К		0.86 typ.		0.034 typ.				
K1	0.35	-	-	0.014	-	-		
Н	0.30	0.41	0.51	0.012	0.016	0.020		
L	0.30	0.43	0.56	0.012	0.017	0.022		
L1	0.06	0.13	0.20	0.002	0.005	0.008		
θ	0°	-	12°	0°	-	12°		
W	0.15	0.25	0.36	0.006	0.010	0.014		
М	0.125 typ.			0.005 typ.				
I: S16-2667-R	ev. M, 09-Jan-17			•				

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RECOMMENDED MINIMUM PADS FOR PowerPAK[®] 1212-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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